

# SILICON RFIC 2.5 GHz FREQUENCY UP-CONVERTER FOR WIRELESS TRANSCEIVER

# **UPC8172TB**

#### **FEATURES**

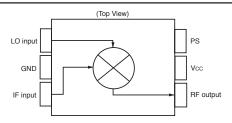
- RECOMMENDED OPERATING FREQUENCY: fRFout = 0.8 to 2.5 GHz
- SUPPLY VOLTAGE: VCC = 2.7 to 3.3 V
- HIGHER IP3 AND CONVERSION GAIN: CG = 9.5 dB TYP OIP3 = +7.5 dBm TYP @ fRFout = 0.9 GHz
- HIGH-DENSITY SURFACE MOUNTING: 6-pin super minimold package

#### **DESCRIPTION**

NEC's UPC8172TB is a silicon monolithic integrated circuit designed as a frequency up-converter for a wireless transceiver transmitter stage. This IC is manufactured using NEC's 30 GHz fmax UHS0 (Ultra High Speed Process) silicon bipolar process. This IC has the same circuit current as the conventional UPC8106TB, but operates at higher frequency, higher gain and lower distortion. Such performance and operation from a 3 volts supply makes this device ideal for mobile communications and wireless LAN applications.

NEC's stringent quality assurance and test procedures ensure the highest reliability and performance.

#### **BLOCK DIAGRAM**



#### **APPLICATIONS**

- PCS1900 MHz
- 2.4 GHz band transmitter/receiver system (wireless LAN, etc.)

#### **ELECTRICAL CHARACTERISTICS**

(Ta = 25°C, Vcc = VRFout = 3.0 V, fiFin = 240 MHz, PLoin = -5 dBm, and VPs ≥2.7 V unless otherwise specified))

|                    | PART NUMBER PACKAGE OUTLINE         |                                    |                                    |                          |                                |       |      | UPC8172TB<br>S06 |      |  |
|--------------------|-------------------------------------|------------------------------------|------------------------------------|--------------------------|--------------------------------|-------|------|------------------|------|--|
| SYMBOLS            | I                                   | PARAMET                            | METERS AND CONDITIONS <sup>1</sup> |                          |                                | UNITS | MIN  | TYP              | MAX  |  |
| Icc                | Circuit Current (no                 | signal)                            |                                    |                          |                                | mA    | 5.5  | 9.0              | 13.0 |  |
| ICC(PS)            | Circuit Current in F                | Power Sav                          | e Mode, VP                         | s = 0 V                  |                                | μΑ    | _    | _                | 2    |  |
| CG1                |                                     | fRFout = 0.                        | 9 GHz, Pifi                        | in = -30                 | dBm                            | dB    | 6.5  | 9.5              | 12.5 |  |
| CG2                | Conversion Gain,                    | fRFout = 1.                        | 9 GHz, Pifi                        | in = -30                 | dBm                            | dB    | 5.5  | 8.5              | 11.5 |  |
| CG3                | -                                   | fRFout = 2.                        | 4 GHz, Pifi                        | in = -30                 | dBm                            | dB    | 5.0  | 8.0              | 11.0 |  |
| Po(SAT)1           | Saturated RF Output Power, fRFout = |                                    | fRFout = 0.9                       | 9 GHz,                   | PIFin = 0 dBm                  | dBm   | -2.5 | 0.5              | _    |  |
| Po(SAT)2           |                                     |                                    | fRFout = 1.9                       | 9 GHz,                   | PIFin = 0 dBm                  | dBm   | -3.5 | 0                | _    |  |
| Po(sat)3           |                                     |                                    | fRFout = 2.                        | : 2.4 GHz, PIFin = 0 dBm |                                | dBm   | -4.0 | -0.5             | _    |  |
|                    | Output Third-Orde                   | r Distortion                       | n Intercept F                      | Point,                   |                                |       |      |                  |      |  |
| OIP31              |                                     | fRFout = 0.                        | 9 GHz                              |                          | fIFin1 = 240 MHz               | dBm   | _    | 7.5              | _    |  |
| OIP <sub>3</sub> 2 |                                     | fRFout = 1.                        | 9 GHz                              |                          | $f_1F_{in}2 = 241 \text{ MHz}$ | dBm   | -    | 6.0              | _    |  |
| OIP33              |                                     | fRFout = 2.                        | 4 GHz                              |                          |                                | dBm   | -    | 4.0              | _    |  |
|                    | Input Third-Order                   | Distortion I                       | ntercept Po                        | oint,                    |                                |       |      |                  |      |  |
| IIP31              |                                     | fRFout = 0.9                       | 9 GHz                              |                          | fIFin1 = 240 MHz               | dBm   | -    | -2.0             | _    |  |
| IIP32              |                                     | fRFout = 1.                        | 9 GHz                              |                          | fIFin2 = 241 MHz               | dBm   |      | -2.5             | _    |  |
| IIP33              |                                     | fRFout = 2.                        | 4 GHz                              |                          |                                | dBm   | -    | -4.0             | _    |  |
| SSB•NF1            | fRFout = 0.9 GHz                    |                                    | = 0.9 GHz,                         | flFin1 =                 | = 240 MHz                      | dB    | _    | 9.5              | _    |  |
| SSB•NF2            | SSB Noise Figure                    | 3 Noise Figure,   fRFout = 1.9 GHz |                                    | flFin1 =                 | = 240 MHz                      | dB    | _    | 10.4             | _    |  |
| SSB•NF3            |                                     | fRFout = 2.4 GHz, $fIFin1 = 240 M$ |                                    | = 240 MHz                | dB                             | _     | 10.6 | _                |      |  |
| TPS(rise)          | Power Save Resp                     | onse Time                          |                                    | Rise 1                   | Time, Vps: GND'Vcc             | μs    | -    | 1                | _    |  |
| TPS(fall)          |                                     |                                    |                                    | Fall Ti                  | me, Vps: Vcc'GND               | μs    | _    | 1.5              | _    |  |

#### Note:

I. fRFout < fLOin @ fRFout = 0.9 GHz fLOin < fRFout @ fRFout = 1.9 GHz/2.4 GHz

California Eastern Laboratories

## **ABSOLUTE MAXIMUM RATINGS<sup>1</sup>**

(TA = +25°C unless otherwise specified)

| (TA = +23 O unicos otriciwise specifica) |                                  |       |             |  |  |  |
|--|----------------------------------|-------|-------------|--|--|--|
| SYMBOLS                                  | PARAMETERS                       | UNITS | RATINGS     |  |  |  |
| Vcc                                      | Supply Voltage                   | V     | 3.6         |  |  |  |
| VPS                                      | PS Pin Input Voltage             | V     | 3.6         |  |  |  |
| PD                                       | Power Dissipation <sup>2</sup>   | mW    | 270         |  |  |  |
| Та                                       | Operating Ambient<br>Temperature | °C    | -40 to +85  |  |  |  |
| Тѕтс                                     | Storage Temperature              | °C    | -55 to +150 |  |  |  |
| Pin                                      | Input Power                      | dBm   | +10         |  |  |  |

#### Notes

- Operation in excess of any one of these conditions may result in permanent damage.
- 2. Mounted on a double-sided copper clad 50x50x1.6 mm epoxy glass PWB, Ta =  $+85^{\circ}$ C.

# RECOMMENDED OPERATING CONDITIONS

| SYMBOLS | PARAMETERS                       | UNITS | MIN | TYP | MAX |
|---------|----------------------------------|-------|-----|-----|-----|
| Vcc     | Supply Voltage <sup>1</sup>      | V     | 2.7 | 3.0 | 3.3 |
| Та      | Operating Ambient Temperature    | °C    | -40 | +25 | +85 |
| PLOin   | Local Input Level <sup>2</sup>   | dBm   | -10 | -5  | 0   |
| fRFout  | RF Output Frequency <sup>3</sup> | GHz   | 0.8 | _   | 2.5 |
| fIFin   | IF Input Frequency               | MHz   | 50  | -   | 400 |

#### Note:

- 1. Same voltage applied to pins 5 and 6.
- 2.  $Zs = 50 \Omega$  (without matching).
- 3. With external matching circuit.

# SERIES PRODUCTS<sup>1</sup> (TA = +25°C, VCC = VRFout = 3.0 V, Zs = ZL = $50 \Omega$ )

| Part Number | Icc  | fRFout     | CG (dB                   |             |             |                          | OIP3 (dBm)  |             |
|-------------|------|------------|--------------------------|-------------|-------------|--------------------------|-------------|-------------|
|             | (mA) | (GHz)      | @RF 0.9 GHz <sup>2</sup> | @RF 1.9 GHz | @RF 2.4 GHz | @RF 0.9 GHz <sup>2</sup> | @RF 1.9 GHz | @RF 2.4 GHz |
| UPC8172TB   | 9    | 0.8 to 2.5 | 9.5                      | 8.5         | 8.0         | +7.5                     | +6.0        | +4.0        |
| UPC8106TB   | 9    | 0.4 to 2.0 | 9                        | 7           | _           | +5.5                     | -1.0        | _           |
| UPC8109TB   | 5    | 0.4 to 2.0 | 6                        | 4           | -           | +1.5                     | +2.0        | _           |
| UPC8163TB   | 16.5 | 0.8 to 2.0 | 9                        | 5.5         | -           | +9.5                     | +6.0        | -           |

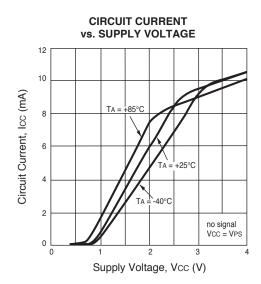
#### Notes:

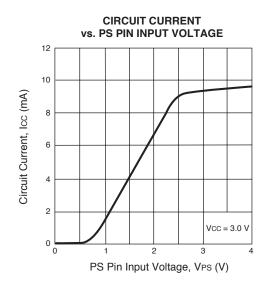
- 1. Typical performance.
- 2. fRFout = 0.83 GHz @ UPC8163TB

# PIN FUNCTIONS (Voltage is measured at Vcc = VPS = VRFOUT = 3.0 V)

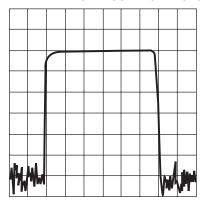
| Pin<br>No. | Pin<br>Name | Applied<br>Voltage<br>(V)                              | Pin<br>Voltage<br>(V) | Function and   | Explanation   | Equivalent Circuit |
|------------|-------------|--|-----------------------|--|---|--------------------|
| 1          | IFinput     | _  | 1.4                   | This pin is the IF input pin mixer (DBM). The input is impedance. The circuit he signals. Also this symmetr specified performance inscondition distribution. For balanced mixer is adopted | designed as a high lps suppress spurious ical circuit can keep ensitive to processthat reason, a double |                    |
| 2          | GND         | GND  | _                     | GND pin. Ground pattern of formed as wide as possible be kept as short as possible inductance.   | e. Track length should  |                    |
| 3          | LOinput     | _  | 2.3                   | Local input pin. Recomme to 0 dBm.   | endable input level is -10  |                    |
| 5          | Vcc         | 2.7 to 3.3   | _                     | Supply voltage pin.  |   |                    |
| 6          | RFoutput    | Same bias<br>as Vcc<br>through<br>external<br>inductor | _                     | This pin is the RF output f<br>balanced mixer. This pin i<br>collector. Due to the high<br>pin should be externally e<br>matching circuit to the nex                                       | s designed as an open<br>impedance output, this<br>quipped with an LC                                   |                    |
| 4          | PS          | Vcc/GND  |                       | Power save control pin. B follows:   | ias controls operate as   | Vcc                |
|            |             |  |                       | Pin Bias   | Control Operation   | \$<br>\$           |
|            |             |  |                       | GND  | Power Save  | <b>}</b> -₩-④      |
|            |             |  |                       |  |   | GND                |

## **TYPICAL PERFORMANCE CURVES** (TA = 25°C)





#### PS PIN CONTROL RESPONSE TIME



REF LVL = 0 dBm

ATT = 10 dB

10 dB/DIV (Vertical axis)

CENTER = 0.9 GHz

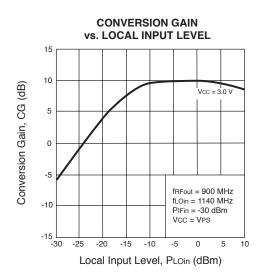
SPAN = 0 Hz

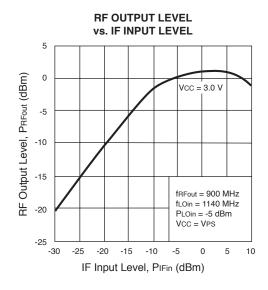
RBW = 3 MHz

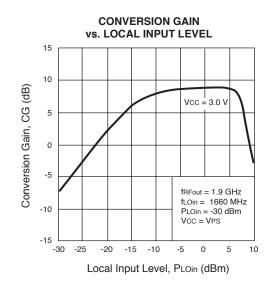
VBW = 3 MHz

SWP = 50  $\mu$ sec

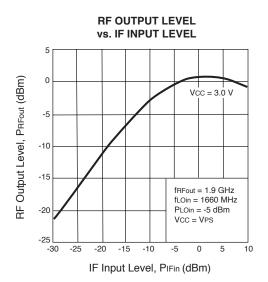
5  $\mu$ sec/DIV (Horizontal axis)

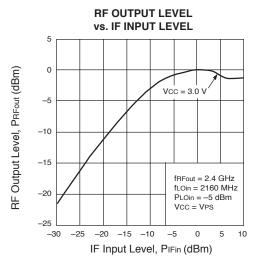


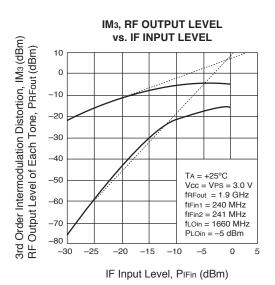


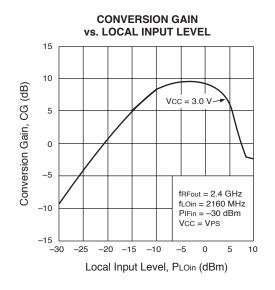


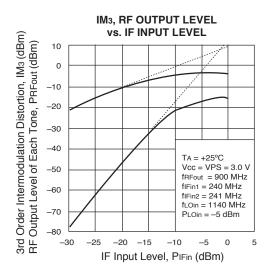
#### **TYPICAL PERFORMANCE CURVES** (TA = 25°C)

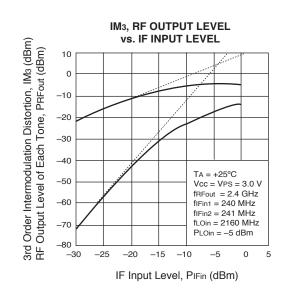




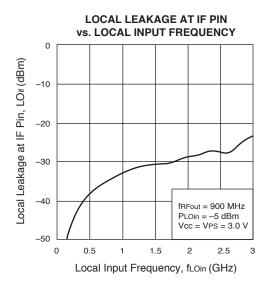


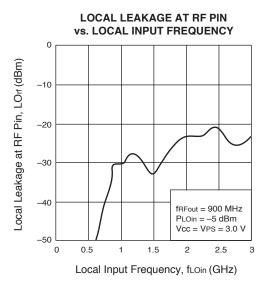


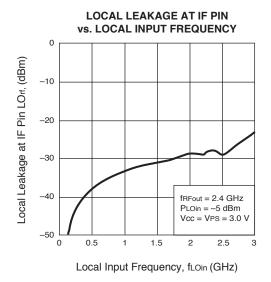


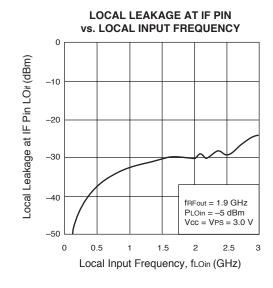


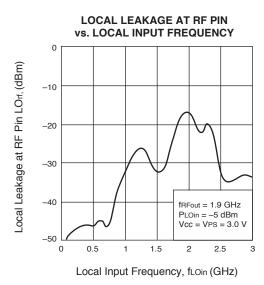
## **TYPICAL PERFORMANCE CURVES** (TA = 25°C)

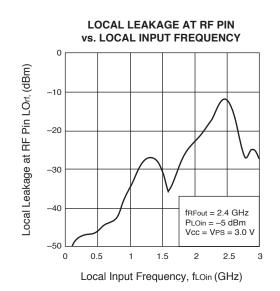






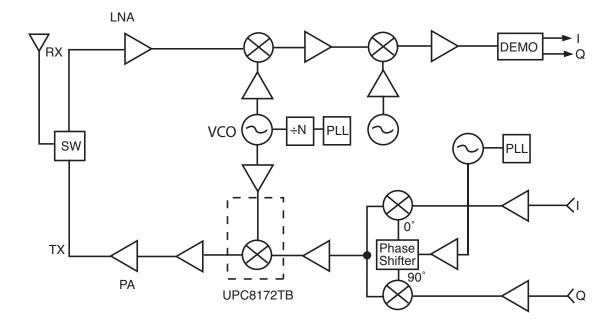






# **SYSTEM APPLICATION EXAMPLE**

## Wireless Transceiver



# S-PARAMETERS FOR EACH PORT (VCC = VPS = VRFout = 3.0 V)

(The paramters are monitored at DUT pins)

#### LO port

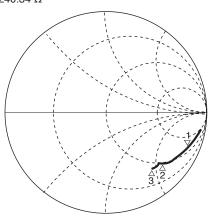
 $\begin{array}{ccc} S_{11} & Z \\ REF \ 1.0 \ Units \\ 1 & 200.0 \ mUnits / \\ & 21.625 \ \Omega \ -91.148 \ \Omega \end{array}$ 

V hp
MARKER 1
1.15 GHz
MARKER 2
1.65 GHz
MARKER 3
2.15 GHz

START 0.40000000 GHz STOP 2.50000000 GHz RF port (without matching)

 $\begin{array}{ccc} S_{22} & Z \\ REF \ 1.0 \ Units \\ 1 & 200.0 \ mUnits/ \\ \hline \hline \hline \hline \hline \\ \hline \\ \hline \\ \hline \\ \hline \end{array} \ \ \, 71.5 \ \Omega \ \ -240.34 \ \Omega \ \, \end{array}$ 

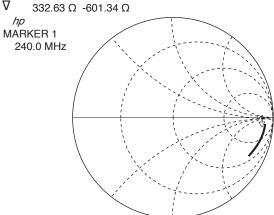
MARKER 1 900 MHz MARKER 2 1.9 GHz MARKER 3 2.5 GHz



START 0.40000000 GHz STOP 2.50000000 GHz

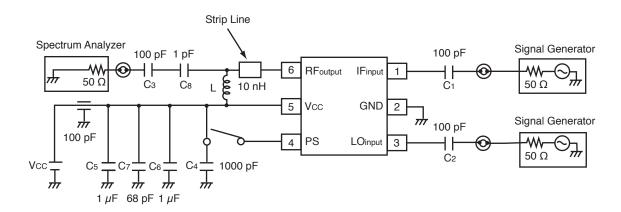
IF port

S<sub>11</sub> Z REF 1.0 Units 1 200.0 mUnits/  $\nabla$  332.63  $\Omega$  -601.34

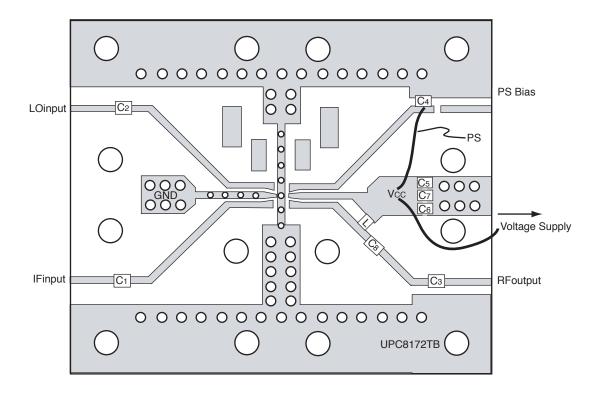


START 0.100000000 GHz STOP 1.000000000 GHz

## TEST CIRCUIT 1 (fRFout = 900 MHz)



#### **EXAMPLE OF TEST CIRCUIT 1 ASSEMBLED ON EVALUATION BOARD**



#### **COMPONENT LIST**

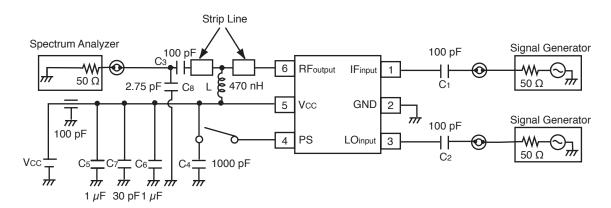
| FORM           | SYMBOL     | VALUE        |
|----------------|------------|--------------|
| Chip Capacitor | C1, C2, C3 | 100 pF       |
|                | C4         | 1000 pF      |
|                | C5, C6     | 1 <i>µ</i> F |
|                | C7         | 68 pF        |
|                | C8         | 1 pF         |
| Chip Inductor  | L          | 10 nH¹       |

Note:

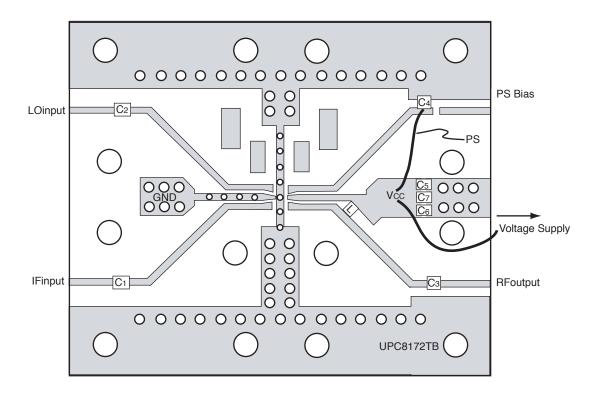
1. 10 nH: LL1608-FH10N (TOKO Co., Ltd.)

- (\*1) 35x42x0.4 mm polymide board, double-sided copper clad
- (\*2) Ground pattern on rear of the board
- (\*3) Solder plated patterns
- (\*4) mmM: Through holes

## TEST CIRCUIT 2 (fRFout = 1.9 GHz)



#### **EXAMPLE OF TEST CIRCUIT 2 ASSEMBLED ON EVALUATION BOARD**



#### **COMPONENT LIST**

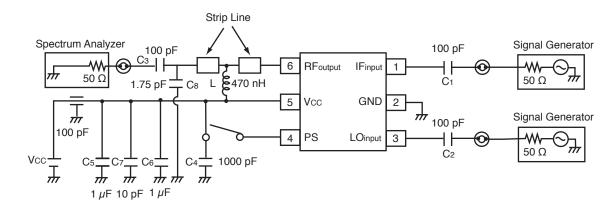
|                |            | 1            |
|----------------|------------|--------------|
| FORM           | SYMBOL     | VALUE        |
| Chip Capacitor | C1, C2, C3 | 100 pF       |
|                | C4         | 1000 pF      |
|                | C5, C6     | 1 <i>µ</i> F |
|                | C7         | 30 pF        |
|                | C8         | 2.75 pF      |
| Chip Inductor  | L          | 470 nH¹      |

Note:

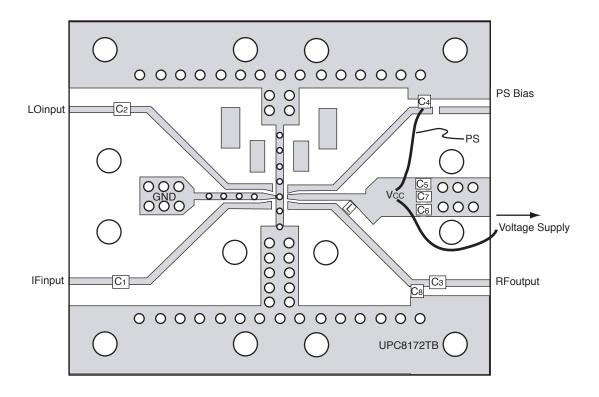
1. 470 nH: LL2012-FR47 (TOKO Co., Ltd.)

- (\*1) 35 x 42 x 0.4 mm polymide board, double-sided copper clad
- (\*2) Ground pattern on rear of the board
- (\*3) Solder plated patterns
- (\*4) mm: Through holes

# TEST CIRCUIT 3 (fRFout = 2.4 GHz)



#### **EXAMPLE OF TEST CIRCUIT 3 ASSEMBLED ON EVALUATION BOARD**



#### **COMPONENT LIST**

| FORM           | SYMBOL         | VALUE        |
|----------------|----------------|--------------|
| Chip Capacitor | C1, C2, C3     | 100 pF       |
|                | C4             | 1000 pF      |
|                | C5, C6         | 1 <i>µ</i> F |
|                | C <sub>7</sub> | 10 pF        |
|                | C8             | 1.75 pF      |
| Chip Inductor  | L              | 470 nH¹      |

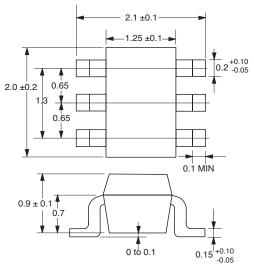
- (\*1) 35 x 42 x 0.4 mm polymide board, double-sided copper clad
- (\*2) Ground pattern on rear of the board
- (\*3) Solder plated patterns
- (\*4) mm: Through holes

Note:

1. 470 nH: LL2012-FR47 (TOKO Co., Ltd.)

#### **OUTLINE DIMENSIONS** (Units in mm)

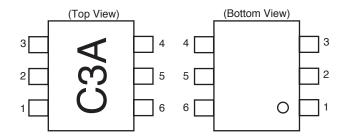
#### **PACKAGE OUTLINE S06**



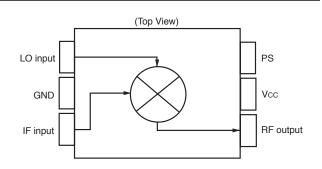
Note:

All dimensions are typical unless otherwise specified.

#### **PIN CONNECTIONS**



#### **BLOCK DIAGRAM**



| PIN NO. | PIN NAME        |
|---------|-----------------|
| 1       | <b>IF</b> input |
| 2       | GND             |
| 3       | LOinput         |
| 4       | PS              |
| 5       | Vcc             |
| 6       | RFoutput        |

#### ORDERING INFORMATION

| Part Number    | Quantity     |
|----------------|--------------|
| UPC8172TB-E3-A | 3 K pcs/reel |

Note: Embossed tape, 8 mm wide. Pins 1, 2 and 3 face the tape perforation side.

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) | Concentration contained in CEL devices |  |
|-------------------------------|---|--|--|
| Lead (Pb)                     | < 1000 PPM  | -A -AZ Not Detected (*)                |  |
| Mercury                       | < 1000 PPM  | Not Detected                           |  |
| Cadmium                       | < 100 PPM   | Not Detected                           |  |
| Hexavalent Chromium           | < 1000 PPM  | Not Detected                           |  |
| PBB                           | < 1000 PPM  | Not Detected                           |  |
| PBDE                          | < 1000 PPM  | Not Detected                           |  |

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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